

MAC-SA5X

Miniature Atomic Clock



Summary

For applications requiring atomic clock stability performance that are unable to accommodate the size and power requirements of rack-mount equipment, the Miniaturized Rb Atomic Clock (MAC-SA5X) is a low-profile, PCB-mountable oscillator. It provides users with a reliable and stable frequency source within minutes of power-on.

By leveraging Coherent Population Trapping (CPT) technology used in the Chip Scale Atomic Clock (CSAC), the MAC-SA5X family of clocks delivers Rubidium-performance in a 2 × 2 inch package. CPT-based oscillators feature a laser to interrogate the Rb atoms and achieve atomic resonance. This allows a reduction in size and power compared to traditional lamp-based clocks, without compromising the performance one would expect from an atomic clock: fast retrace, resistance to static g-forces, exceptional temperature stability and low frequency drift rates.

MAC-SA5X shares the same footprint with the legacy SA.3Xm and many traditional OCXOs, but its performance versus size is unparalleled. Its hardware and software have been completely redesigned to add new features such as 1PPS synchronization, improve stability, and operate over a wide temperature range of thermal environments. This combination of features, along with the ability to quickly provide an atomic frequency reference, is particularly powerful for mobile applications where every minute and every Watt counts.



This product is compatible with Microchips Clockstudio™ software tool for control and analysis of atomic clocks: microchip.com/clockstudio

SA5X Family

Two performance levels are offered to meet a variety of performance and budgetary requirements: SA53 and SA55. The base-performance SA53 is targeted for applications that require an economical solution for frequency stability, such as portable test equipment. The high-performance SA55 has superior aging, TempCo, stability, and phase noise, compared to the SA53 for applications that require precision frequency and long holdover.

Applications

- LTE base stations
- Smart grid
- Enterprise network infrastructure
- Portable test equipment
- Autonomous sensor networks
- Data center timing card

Features

- Sub-microsecond holdover for 72 hour missions¹
- Drift rate $<5 \times 10^{-11}$ Hz/Hz /mo (SA55)
- Operating temperature -40°C to $+75^{\circ}\text{C}$
- Maximum temperature-induced frequency errors $<5 \times 10^{-11}$ Hz/Hz (SA55)
- Rapid, reliable warm-up time <8 minutes
- 1PPS output and input for easy calibration/synchronization
- New software allows greater control and health monitoring
- Small size: 2 × 2 × 0.7 in. (51 × 51 × 18 mm)

¹Predicted assuming zero initial phase/frequency offset, static environment, 25 °C, on for 30 days prior to holdover. (SA55)

Specifications @ 5V and 25°C (ambient), unless noted otherwise

Electrical

RF Output (Pin 3)			
Frequency	10 MHz		
Format	CMOS (0 to 3.3V)		
Load Impedance	1 MΩ		
Rise/Fall time	< 4 ns		
Duty Cycle	50% ±10%		
Quantity	1		
1 PPS Output (Pins J1-17, 19)			
Format	LVDS Square Wave		
Level	EIA/TIA-644 compliant		
Rise/Fall time	< 4 ns		
Pulse Width (Programmable)	20 μs (100 nS – 100 mS, 10 nS step)		
Quantity	1		
1 PPS Input (Pins J1-5,7 or J1-1,3)			
Format	LVDS Rising Edge		
Level	EIA/TIA-644 compliant		
Quantity	2		
Minimum Pulse Width	100 ns		
Serial Communication (Pins 7,8)			
Protocol	RS232 UART		
Format	CMOS (0 to 3.3V)		
Tx/Rx Impedance	1 MΩ		
BAUD rate	57600		
High Speed Communication (Pins J1-2,4,6)			
Protocol	USB 2.0 compatible		
Built In Test Equipment (BITE) Output (Pin 6)			
Format	CMOS (0 to 3.3V)		
Load Impedance	1 MΩ		
Logic	Low = Normal Operation High = No Physics Lock		
Alarm Output (Pin J1-20)			
Format	CMOS (0 to 3.3V)		
Load Impedance	1 MΩ		
Logic	Low = Normal Operation, High = Alarm		
Power Input (Pin 5)			
Voltage Range	4.5 to 32V DC		
Power Consumption	Typical (W)	Max (W)	
Operating Temperature ²	65°C:	4.0	6
	25°C:	6.3	8
	-10°C:	8.3	11
	-40°C:	10.0	14
Warmup	@ All Temps:		14

²Ambient temperature. Thermal environment will affect exact power consumption/TempCo. Contact factory for details. DO NOT EXCEED 75°C MEASURED AT BASEPLATE.

Performance Parameters

Time to Lock	< 8m (> -10°C) < 12m (< -10°C)
Analog Tuning Range	> ±1 × 10 ⁻⁸ Hz/Hz (Resolution: 1 × 10 ⁻¹¹ Hz/Hz) (0 to 5V into 5 kΩ)
Digital Tuning Range	±1 × 10 ⁻⁶ Hz/Hz (Resolution: 1 × 10 ⁻¹⁵ Hz/Hz)
Frequency Offset	< ±5 × 10 ⁻¹¹ Hz/Hz (at shipment)
Retrace	< ±5 × 10 ⁻¹¹ Hz/Hz (after 24h on, 48h off, 12h on)
1PPS output jitter	< 1 ns (100s Avg)

Stability

ADEV	SA55 (Hz/Hz)	SA53 (Hz/Hz)
τ = 1 s	< 1.5 × 10 ⁻¹¹	< 3 × 10 ⁻¹¹
τ = 10 s	< 5 × 10 ⁻¹²	< 1 × 10 ⁻¹¹
τ = 100 s	< 1.5 × 10 ⁻¹²	< 3 × 10 ⁻¹²
τ = 1,000 s	< 5 × 10 ⁻¹³	< 1 × 10 ⁻¹²
τ = 10,000 s	< 1.5 × 10 ⁻¹²	< 3 × 10 ⁻¹²
Frequency Drift	SA55 (Hz/Hz)	SA53 (Hz/Hz)
Monthly ³	< 5 × 10 ⁻¹¹	< 1 × 10 ⁻¹⁰
Yearly	< 6 × 10 ⁻¹⁰	< 1.5 × 10 ⁻⁹
Daily ⁴	< 2.5 × 10 ⁻¹¹	< 2.5 × 10 ⁻¹¹

³After 1 month of continuous operation

⁴After 1 day of continuous operation

Phase Noise (SSB)	SA55 (dBc/Hz)	SA53 (dBc/Hz)
1 Hz	< -70	< -65
10 Hz	< -90	< -85
100 Hz	< -114	< -112
1 kHz	< -135	< -130
10 kHz	< -140	< -140
Spurious (non-harmonic)	< -85 dBc	
TempCo (Peak-to-Peak)	SA55 (Hz/Hz)	SA53 (Hz/Hz)
-40 to +75 °C ²	< 5 × 10 ⁻¹¹	< 1 × 10 ⁻¹⁰

Environmental

Operating	
Temperature Range	-40 °C to +75 °C ²
Magnetic Sensitivity (frequency change)	< 2 Gauss ($\pm 7 \times 10^{-11}$ Hz/Hz /Gauss)
Voltage Sensitivity (frequency change)	± 1 V DC ($< 1 \times 10^{-11}$ Hz/Hz, p-p)
Vibration	7.7 g_{rms} /axis per MIL-STD-810, Fig 514.7E-1, Category 24 (General Minimum Integrity Exposure): no loss of lock.
Shock	30g, 11 ms half-sine pulse per MIL-STD-202, Method 213, Test Condition J, 18 shocks (3+ & 3- per axis): no loss of lock, $\leq 4 \times 10^{-8}$ Hz/Hz frequency perturbation momentary
Humidity	GR-63-CORE, issue 4, April 2012, section 4.1.2
Altitude	50,000 feet

Non-Operating (Storage & Transport)	
Temperature Range	-55 °C to +100 °C
Vibration	10.9 Grms @ 1 hr/axis per MIL-STD-810, Fig 514.7E-1, Category 24 (General Minimum Integrity Exposure)
Shock	50g, 11 ms half-sine pulse per MIL-STD-202, Method 213, Test Condition A, 18 shocks (3+ & 3- per axis)
Altitude	70,000 feet

Name	Part Number	Description
MAC-SA55	090-44550-01	5 x 10 ⁻¹¹ /mo, 5 x 10 ⁻¹¹ TempCo, AT disabled
MAC-SA53	090-44530-01	1x10 ⁻¹⁰ /mo, 1x10 ⁻¹⁰ TempCo, AT disabled Note: AT = Analog Tuning
MAC-SA5X Kit	090-44500-000	Developers Kit. Does not include MAC

Mechanical

Size	2 x 2 x 0.7 in.
Weight	< 100 g (3.5 oz)
MTBF	149,743h (Ground Benign, per MIL-HDBK-217F, 40°C baseplate) 2,078,563h (Ground Fixed, Telcordia SR-332, 40°C baseplate)
RoHS	2011/65/EU

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Baseplate Connector	
Pin	Function
1	Analog Tuning
2	Case Ground
3	RF Output
4	GND (Signal & Supply)
5	Input Supply (4.5 to 32V)
6	BITE
7	RS-232 Tx
8	RS-232 Rx

J1 Connector	
Pin	Function
1	PPS-in 1+
3	PPS-in 1-
5	PPS-in 0+
7	PPS-in 0-
9	GND
11	NC
13	NC
15	GND
17	PPS-out +
19	PPS-out -
2	USB data +
4	USB data -
6	USB Power
8	GND
10	NC
12	NC
14	NC
16	NC
18	NC
20	ALARM



